

## CCD ANALOG FRONT-END FOR DIGITAL CAMERAS

Check for Samples: [VSP2560](#), [VSP2562](#), [VSP2566](#)

### FEATURES

- **CCD Signal Processing:**
  - 36-MHz Correlated Double Sampling (CDS)
- **Output Resolution:**
  - VSP2560 (10-Bit)
  - VSP2562 (12-Bit)
  - VSP2566 (16-Bit)
- **16-Bit Analog-to-Digital Conversion:**
  - 36-MHz Conversion Rate
  - No Missing Codes Ensured
- **80-dB Input-Referred SNR (at Gain = 12 dB)**
- **Programmable Black Level Clamping**
- **Programmable Gain Amp (PGA):**
  - -9 dB to +44 dB
  - -3 dB to +18 dB (Analog Front Gain)
  - -6 dB to +26 dB (Digital Gain)
- **Portable Operation:**
  - Low Voltage: 2.7 V to 3.6 V
  - Low Power: 86 mW at 3.0 V, 36 MHz
  - Low Power: 6 mW (Standby Mode)

- **Two-Channel, General-Purpose, 8-Bit DAC**

### DESCRIPTION

The VSP2560/62/66 are a family of complete mixed-signal processing ICs for digital cameras that provide correlated double sampling (CDS) and analog-to-digital conversion for the output of CCD arrays. The CDS extracts the pixel video information from the CCD signal, and the analog-to-digital converter (ADC) converts the digital signal. For varying illumination conditions, a very stable gain control of -9 dB to 44 dB is provided. The gain control is linear in dB. Input signal clamping and offset correction of the input CDS are also provided.

Offset correction is performed by the optical black (OB) level calibration loop, and is held in calibrated black level clamping for an accurate black level reference. Additionally, the black level is quickly recovered after gain changes. The VSP2560/62/66 are available in LQFP-48 packages and operate from single +3 V supplies.

**Table 1. FEATURE COMPARISON BY DEVICE**

DEVICE	RESOLUTION (Bits)	TRANSFER CHARACTERISTICS (LSB)		OB CLAMP LOOP (LSB)		
		DNL	INL	PROGRAMMABLE RANGE	OBCLP LEVEL	OB LEVEL
VSP2560	10	±0.5	±1	16 to 78	32	2
VSP2562	12	±0.5	±2	64 to 312	128	8
VSP2566	16	±2	±32	1024 to 4992	2048	128

**PRODUCT PREVIEW**


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**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
VSP2560PTR	ACTIVE	LQFP	PT	48	1000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	VSP2560	<a href="#">Samples</a>
VSP2562PT	ACTIVE	LQFP	PT	48	250	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-25 to 85	VSP2562	<a href="#">Samples</a>
VSP2566PT	ACTIVE	LQFP	PT	48	250	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-25 to 85	VSP2566	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
VSP2560PTR	LQFP	PT	48	1000	330.0	17.4	9.5	9.5	2.0	12.0	16.0	Q2

**TAPE AND REEL BOX DIMENSIONS**

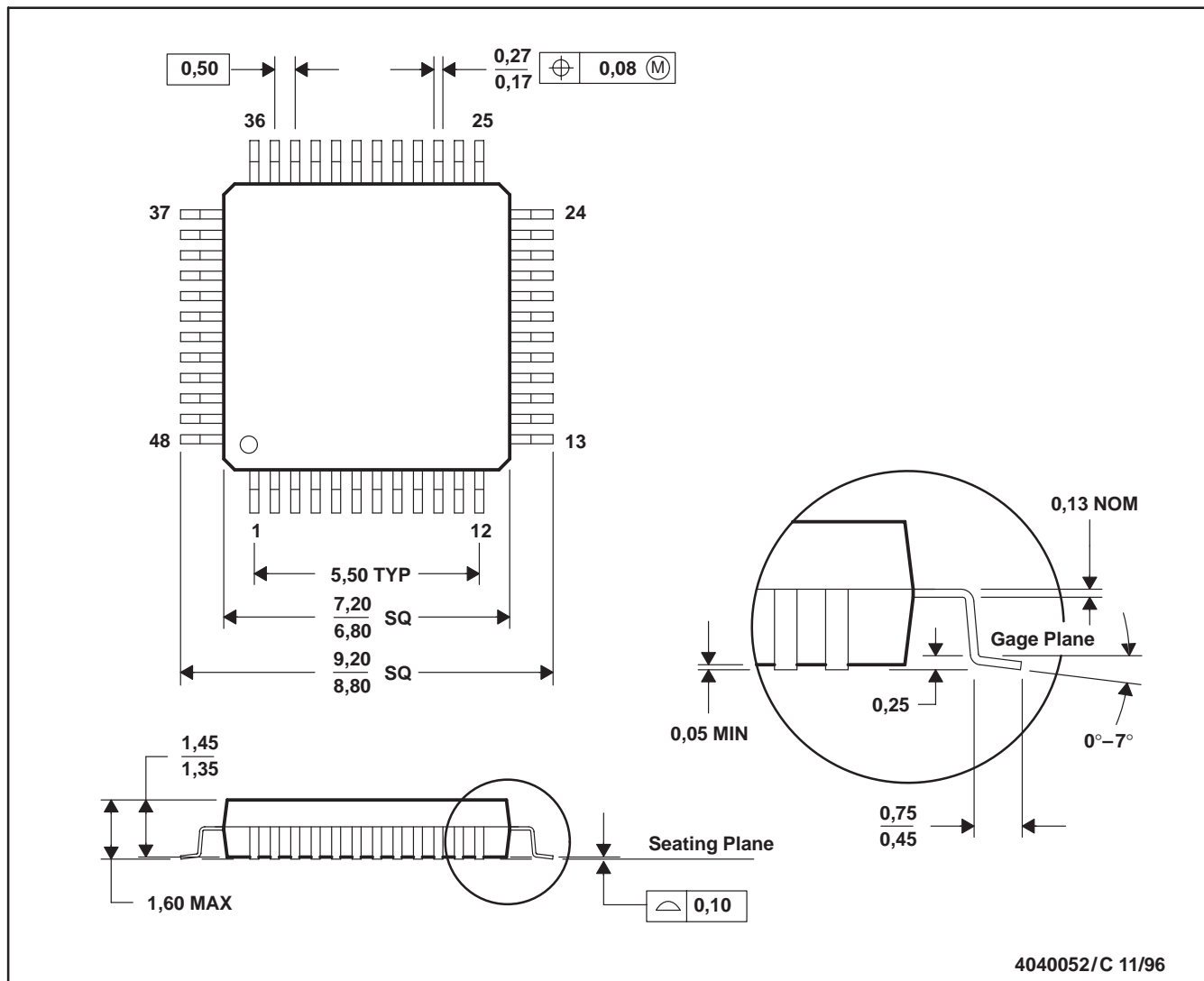


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
VSP2560PTR	LQFP	PT	48	1000	333.2	345.9	28.6

PT (S-PQFP-G48)

PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-026  
 D. This may also be a thermally enhanced plastic package with leads connected to the die pads.

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